Product Preview Field Stop Trench IGBT 75 A, 650 V

Using the novel field stop 3rd generation IGBT technology, FGH75T65SHDTLN4 offers the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction loss and switching loss are essential.

Features

- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(Sat)} = 1.6 V (Typ.) @ I_C = 75 A$
- 100% of the Parts Tested for I_{LM}(1)
- High Input Impedance
- Fast Switching
- Tight Parameter Distribution
- Pb Free and RoHS Compliant
- Not Recommended for Reflow and Full PKG Dipping **Typical Applications**
- Solar Inverter UPS Welder
- Telecom ESS PFC

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbo	ol Value	Unit
V _{CES}	650	V
V _{GES}	±20 ±30	V
25°C I _C	150	А
00°C	75	
I _{LM}	300	А
2) I _{CM}	300	А
25°C I _F	125	А
00°C	75	
lote 2) I _{FM}	300	А
25°C P _D	455	W
00°C	227	
ure T _J , T _{ST}	G -55 to +175	°C
I TL	300	°C
1	Vces Ic Ic Ic Ic Ico°C Ic Ioo°C Ioo°C Ioo°C Ioo°C Ioo°C Iure TJ, Tst	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} = 300 A, R_{G} = 73 Ω , Inductive Load

2. Repetitive rating: pulse width limited by max. Junction temperature

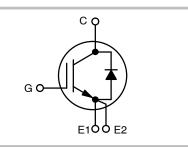
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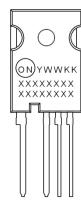
75 A, 650 V V_{CE(sat)} = 1.6 V E_{on} = 1.06 mJ





THIN LEADS CASE 340CW

DEVICE MARKING INFORMATION



Line 1: Date Code Line 2: Device Marking Line 3: Device Marking

ORDERING INFORMATION

Device	Package	Shipping
FGH75T65SHDTLN4	TO-247	30 Units / Tube

Table 1. THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, for IGBT	0.33	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, for Diode	0.65	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	40	°C/W

Table 2. ELECTRICAL CHARACTERISTICS (T _ = 25 $^{\circ}\text{C}$ unless otherwise noted)

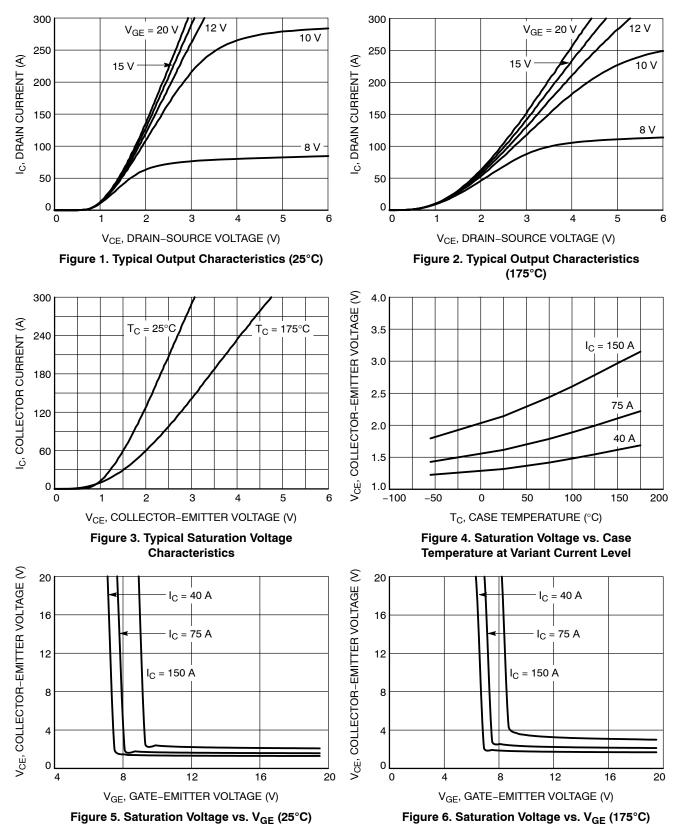
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS			-			
Collector-emitter breakdown voltage, gate-emitter short-circuited	BV _{CES}	V_{GE} = 0 V, I_{C} = 1 mA	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$\frac{\Delta \text{BV}_{\text{CES}}}{\Delta \text{T}_{\text{J}}}$	V_{GE} = 0 V, I _C = 1 mA	-	0.65	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	I _{CES}	V_{GE} = 0 V, V_{CE} = 650 V	-	-	250	μΑ
Gate leakage current, collector-emitter short-circuited	I _{GES}	V_{GE} = ±20 V, V_{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter threshold voltage	V _{GE(th)}	V_{GE} = V_{CE} , I_C = 75 mA	4.0	5.5	7.5	V
Collector-emitter saturation voltage	V _{CE(sat)}	V_{GE} = 15 V, I _C = 75 A, V _{GE} = 15 V, I _C = 75 A, T _J = 175°C		1.6 2.28	2.1 _	mV/°C
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	3710	-	pF
Output Capacitance	C _{oes}		-	183	_	1
Reverse Transfer Capacitance	C _{res}		-	43	_	
Gate Charge Total	Qg	V_{CE} = 400 V, I_{C} = 75 A, V_{GE} = 15 V	-	126	-	nC
Gate-to-Emitter Charge	Q _{ge}		-	24.1	_	
Gate-to-Collector Charge	Q _{gc}		-	47.6	_	
SWITCHING CHARACTERISTICS, INDU	JCTIVE LOAD	1				
Turn-On Delay Time	t _{d(on)}	$T_{C} = 25^{\circ}C$	-	55	-	ns
Rise Time	t _r	V_{CC} = 400 V, I _C = 75 A Rg = 15 Ω	-	50	-	
Turn-Off Delay Time	t _{d(off)}	V _{GE} = 15 V Inductive Load, T _C = 25°C	-	189	-	
Fall Time	t _f	, 6	-	39	-	
Turn-On Switching Loss	Eon		-	1.06	-	mJ
Turn–Off Switching Loss	E _{off}		-	1.56	-	
Total Switching Loss	E _{ts}		-	2.62	-	
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_{C} = 75 \text{ A}$	-	48	-	ns
Rise Time	t _r	Rg = 15 Ω V _{GE} = 15 V	-	56	-	
Turn-Off Delay Time	t _{d(off)}	Inductive Load, $T_C = 175^{\circ}C$	-	205	-	
Fall Time	t _f		-	40	-	
Turn–On Switching Loss	E _{on}		-	2.34	-	mJ
Turn–Off Switching Loss	E _{off}		-	1.81	-	
Total Switching Loss	E _{ts}		-	4.15	-	
DIODE CHARACTERISTICS						
Forward voltage	V _F	I _F = 75 A I _F = 75 A, Τ _J = 175°C		1.8 1.7	2.1 _	V

Table 2. ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

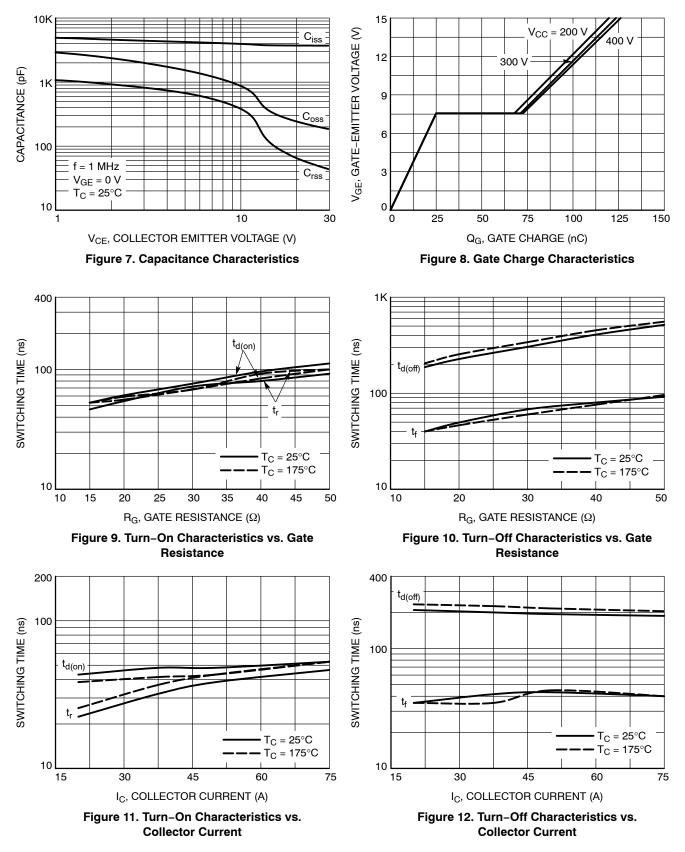
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
DIODE CHARACTERISTICS						
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C$	-	36	-	ns
Reverse Recovery Charge	Q _{rr}	I _F = 75 A, di _F /dt = 200 A/μs	-	18	-	
Reverse Recovery Time	t _{rr}	T _J = 175°C I _F = 75 A, di _F /dt = 200 A/μs	-	270	-	ns
Reverse Recovery Charge	Q _{rr}	$I_F = 75 \text{ A}, \text{ d}_F/\text{d}_f = 200 \text{ A}/\mu \text{s}$	-	2199	-	μC
Reverse Recovery Energy	E _{rec}		-	160	-	μJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

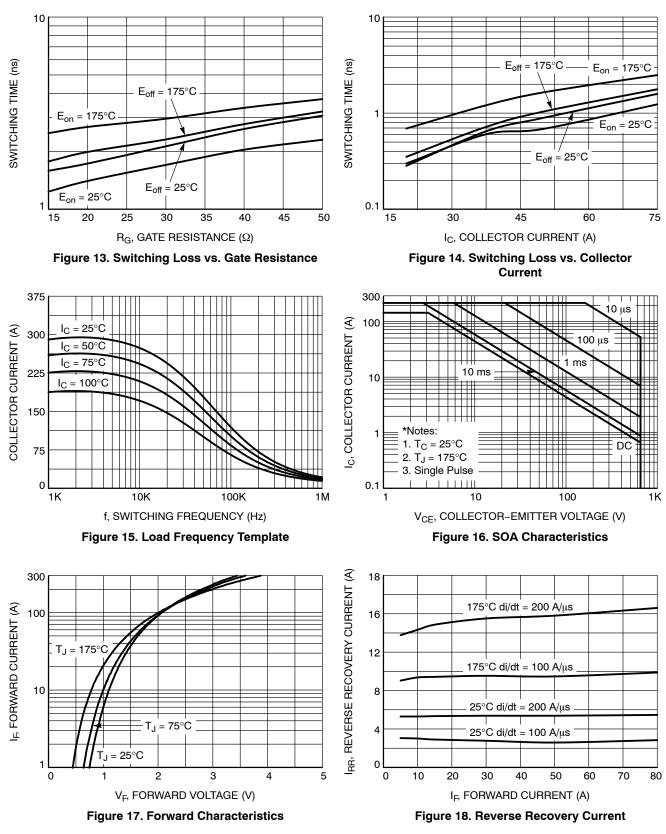
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

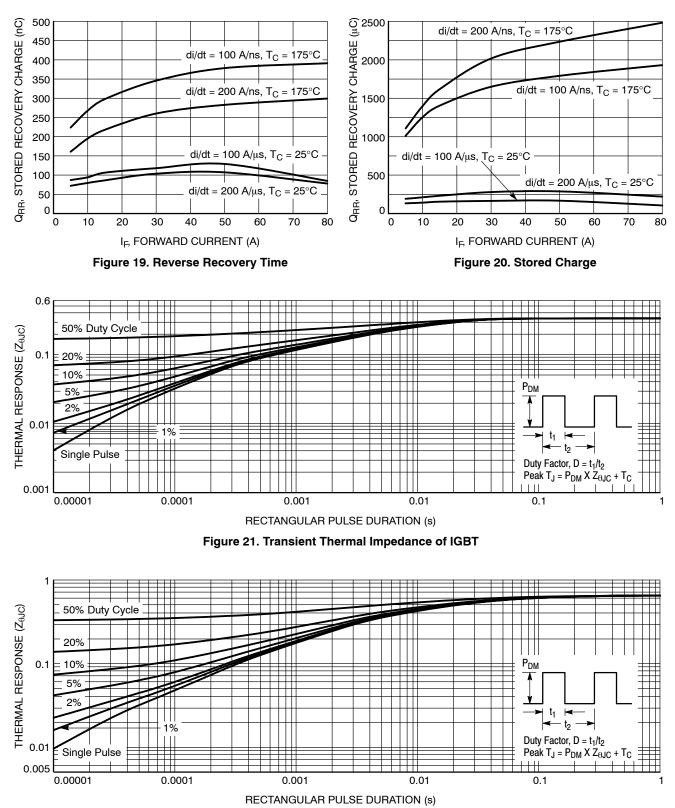
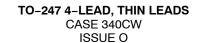
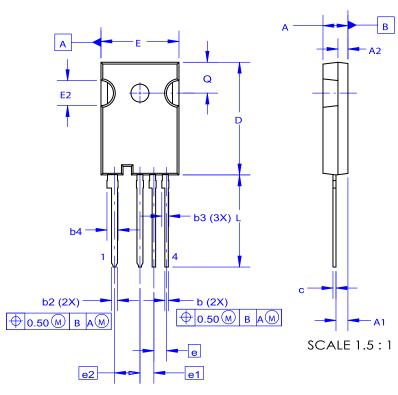


Figure 22. Transient Thermal Impedance of Diode

PACKAGE DIMENSIONS

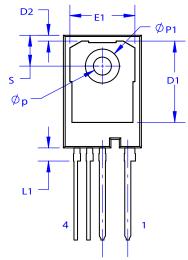




SCALE 1.5 : 1

NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS,MOLD FLASH AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.



SCALE 1.5:1

	MILLIMETERS				
DIM	MIN	NOM	MAX		
А	4.80	5.00	5.20		
A1	1.90	2.40	2.90		
A2	1.80	2.00	2.20		
b	0.57	0.70	0.83		
b2	1.07	1.20	1.33		
b3	1.20	1.40	1.60		
b4	2.02	2.22	2.42		
с	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.30	16.50		
D2	0.97	1.17	1.37		
е		2.54			
e1		2.79			
e2		5.08			
E	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E2	4.80	5.00	5.20		
L	18.12	18.42	18.72		
L1	2.42	2.62	2.82		
Øp	3.40	3.60	3.80		
ØP1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

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